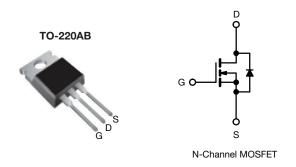


Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V_{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.084		
Q _g max. (nC)	10	34		
Q _{gs} (nC)	16			
Q _{gd} (nC)	4	8		
Configuration	Single			

FEATURES

- A specific on resistance (m Ω -cm²) reduction of 25 %
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP35N60EF-GE3

PARAMETER		SYM	BOL	LIMIT	UNIT	
Drain-source voltage		VD	os	600	V	
Gate-source voltage		VG	ŝS	± 30	V	
Continuous drain current ($T_{,1} = 150 \ ^{\circ}C$)	V_{GS} at 10 V $T_C = 2$	= 25 °C	1	32	А	
Continuous drain current $(1j = 150 \text{ C})$	V_{GS} at 10 V $T_C = 10$	0°C		20		
Pulsed drain current ^a		I _{DI}	м	80		
Linear derating factor				2.0	W/°C	
Single pulse avalanche energy ^b		EA	NS	298	mJ	
Maximum power dissipation			D	250	W	
Operating junction and storage temperature range		Т _Ј , Т	T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		(al t	100		
Reverse diode dv/dt d		dv/	ai	50	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.6 A

c. 1.6 mm from case

d. I_{SD} = 17 A, di/dt = 300 A/µs, starting T_J = 25 °C

S20-0091-Rev. B, 17-Feb-2020

1



COMPLIANT HALOGEN

FREE



Vishay Siliconix

TYP.	MAX.	UNIT
		UNIT
-	62	°C/W
-	0.5	C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						1	I
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.66	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 1	μA
7		V _{DS} =	: 480 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 17 A	-	0.084	0.097	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 17 A	-	8	-	S
Dynamic				•	•		
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2568	-	
Output capacitance	C _{oss}	,	$V_{\rm DS} = 100 \rm V,$	-	113	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}			-	81	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{\rm DS} = 0$	/ to 480 V, V_{GS} = 0 V	-	421	-	
Total gate charge	Qg			-	89	134	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	I _D = 17 A, V _{DS} = 480 V	-	16	-	nC
Gate-drain charge	Q _{gd}			-	48	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	V _{DD} =	= 480 V, I _D = 17 A,	-	85	170	
Turn-off delay time	t _{d(off)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	96	192	- ns
Fall time	t _f			-	61	122	
Gate input resistance	Rg	f = 1	MHz, open drain	0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	s	•		•	•	•	
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	32	
Pulsed diode forward current	I _{SM}	integral revers p - n junction		-	-	80	A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 17 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	150	300	ns
Reverse recovery charge	Q _{rr}	$T_{J} = 2\xi$	5 °C, I _F = I _S = 17 A, 00 A/µs, V _R = 400 V	-	1.1	2.2	μC
Reverse recovery current	I _{RRM}		$00 A \mu s, v_{R} = 400 v$	-	14	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

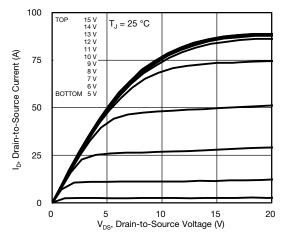


Fig. 1 - Typical Output Characteristics

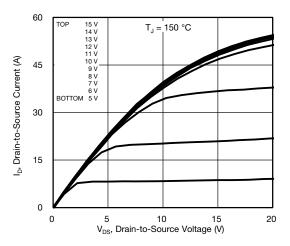


Fig. 2 - Typical Output Characteristics

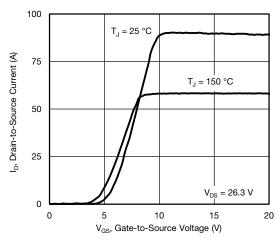


Fig. 3 - Typical Transfer Characteristics

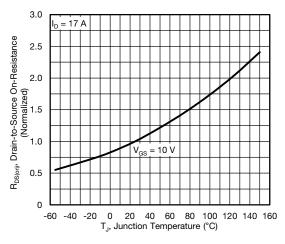


Fig. 4 - Normalized On-Resistance vs. Temperature

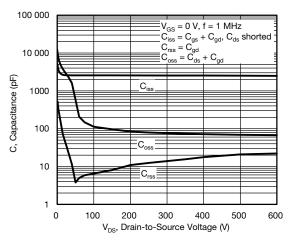


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

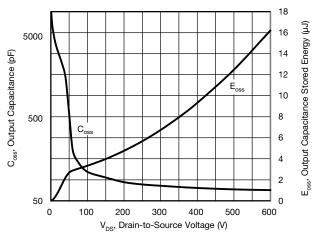


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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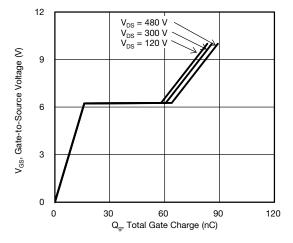


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

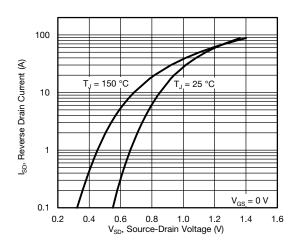
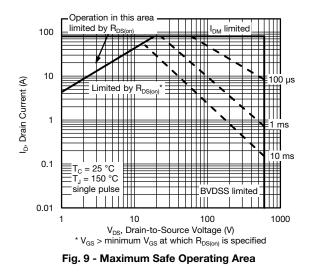


Fig. 8 - Typical Source-Drain Diode Forward Voltage



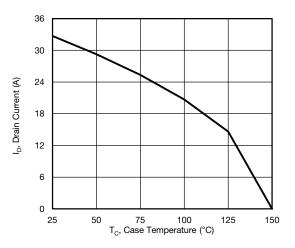


Fig. 10 - Maximum Drain Current vs. Case Temperature

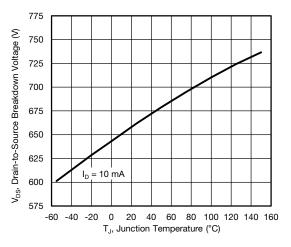
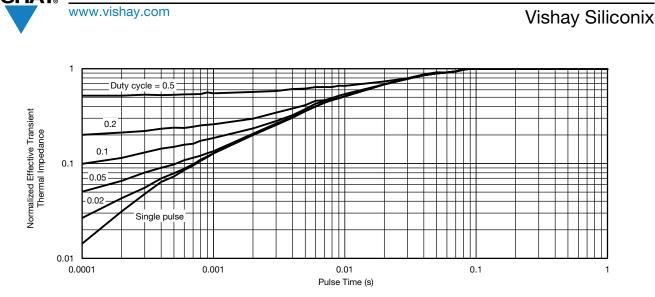
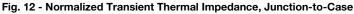


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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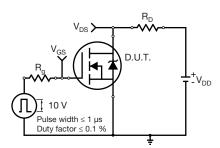


Fig. 13 - Switching Time Test Circuit

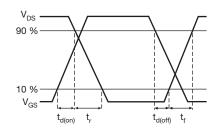


Fig. 14 - Switching Time Waveforms

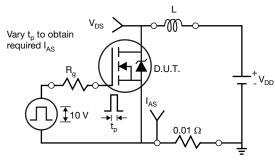


Fig. 15 - Unclamped Inductive Test Circuit

V_{DS} I_{AS} _____ Fig. 16 - Unclamped Inductive Waveforms

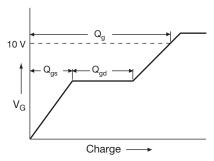


Fig. 17 - Basic Gate Charge Waveform

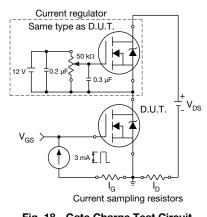
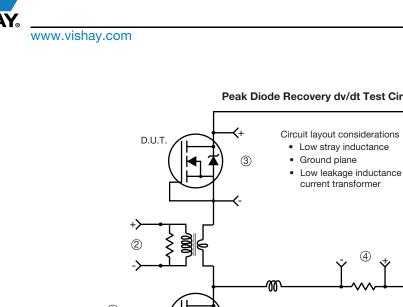


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit

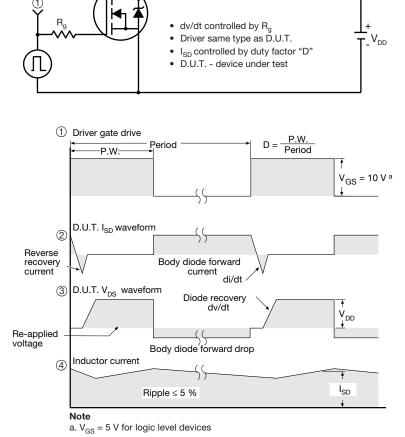


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon



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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?92107</u>.



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TO-220-1



DIM	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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